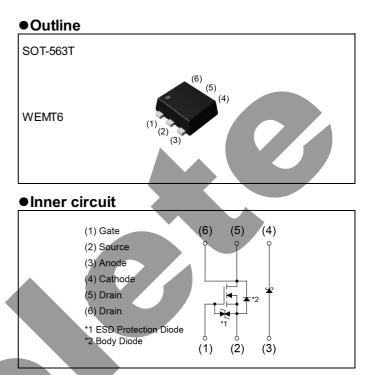
ES6U2

V _{DSS}	20V
R _{DS(on)} (Max.)	180mΩ
I _D	±1.5A
P _D	0.8W

Features

ROHM

- 1) Nch MOSFET and shottky barrier diode are put in WEMT6 package.
- 2) High-speed switching and Low onresistance.
- 3) Low voltage drive(1.5V drive)
- 4) Built in Low V_F schottky barrier diode.



Packaging specifications

	Packing	Embossed Tape
	Reel size (mm)	180
Туре	Tape width (mm)	8
	Basic ordering unit (pcs)	8000
	Taping code	T2R
	Marking	U02

• Absolute maximum ratings (T_a = 25°C ,unless otherwise specified)

< MOSFET >

Application

Switching

Parameter	Symbol	Value	Unit
Drain - Source voltage	V _{DSS}	20	V
Gate - Source voltage	V _{GSS}	±10	V
Continuous drain current	Ι _D	±1.5	A
Pulsed drain current	۱ _{DP} *1	±3	А
Continuous source current (body diode)	I _S	0.5	А
Pulsed source current (body diode)	I _{SP} *1	3	А
Power dissipation	P _D *2	0.7	W/element
Junction temperature	Tj	150	C°

• Absolute maximum ratings ($T_a = 25^{\circ}C$)

< Diode >

Parameter	Symbol	Value	Unit
Repetitive peak reverse voltage	V _{RM}	25	V
Reverse voltage	V _R	20	V
Forward current	I _F	0.5	A
Forward current surge peak	I _{FSM} *3	2.0	A
Power dissipation	P _D *2	0.5	W/element
Junction temperature	Tj	150	°C

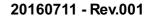
< MOSFET + Diode >

Parameter	Symbol	Value	Unit
Power dissipation	P_{D}^{*2}	0.8	W/total
Operating junction and storage temperature range	T _{stg}	-55 to +150	°C

• Electrical characteristics (T_a = 25°C)

< MOSFET >

Deremeter	Currada al	Conditions	Values			Linit
Parameter	Symbol Conditions		Min.	Тур.	Max.	Unit
Gate - Source leakage current	I _{GSS}	V_{GS} = ±10V, V_{DS} = 0V	-	-	±10	μA
Drain - Source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 1mA	20	-	-	V
Zero gate voltage drain current	I _{DSS}	V _{DS} = 20V, V _{GS} = 0V	-	-	1	μA
Gate threshold voltage	$V_{GS(th)}$	V _{DS} = 10V, I _D = 1mA	0.3	-	1.0	V
		V _{GS} = 4.5V, I _D = 1.5A	-	130	180	
Static drain - source	D *4	V _{GS} = 2.5V, I _D = 1.5A	-	170	240	m0
on - state resistance	$R_{DS(on)}^{*4}$	V _{GS} = 1.8V, I _D = 0.8A	-	220	310	mΩ
		V _{GS} = 1.5V, I _D = 0.3A	-	300	600	
Forward Transfer Admittance	Y _{fs} *4	V _{DS} = 10V, I _D = 1.5A	1.6	-	-	S



ROHM

< MOSFET >

Deremeter	Symbol Conditions		Values			Linit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input capacitance	C _{iss}	V _{GS} = 0V	-	110	-	
Output capacitance	C _{oss}	V _{DS} = 10V	-	18		pF
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	15	_	
Turn - on delay time	$t_{d(on)}^{*4}$	$V_{DD} \simeq 10V$, $V_{GS} = 4.5V$	-	5	-	
Rise time	t _r *4	I _D = 1A	-	5		20
Turn - off delay time	$t_{d(off)}^{*4}$	R _L = 10Ω	-	20	-	ns
Fall time	t _f *4	R _G = 10Ω		3	-	

• Gate charge characteristics ($T_a = 25^{\circ}C$)

< MOSFET >

Deremeter	Symbol	Conditions		Values		Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Total gate charge	Q _g ^{*4}		-	1.8	-	
Gate - Source charge	Q _{gs} *4 V	_{DD} ≃ 10V, I _D = 1.5A _{GS} = 4.5V	-	0.3	-	nC
Gate - Drain charge	Q _{gd} *4		-	0.3	-	

•Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

< MOSFET >

Daramatar	Symbol Condit	Conditions			Values	
Parameter		Conditions	Min.	Тур.	Max.	Unit
Forward voltage	V_{SD}^{*4}	V _{GS} = 0V, I _S = 1.5A	-	-	1.2	V



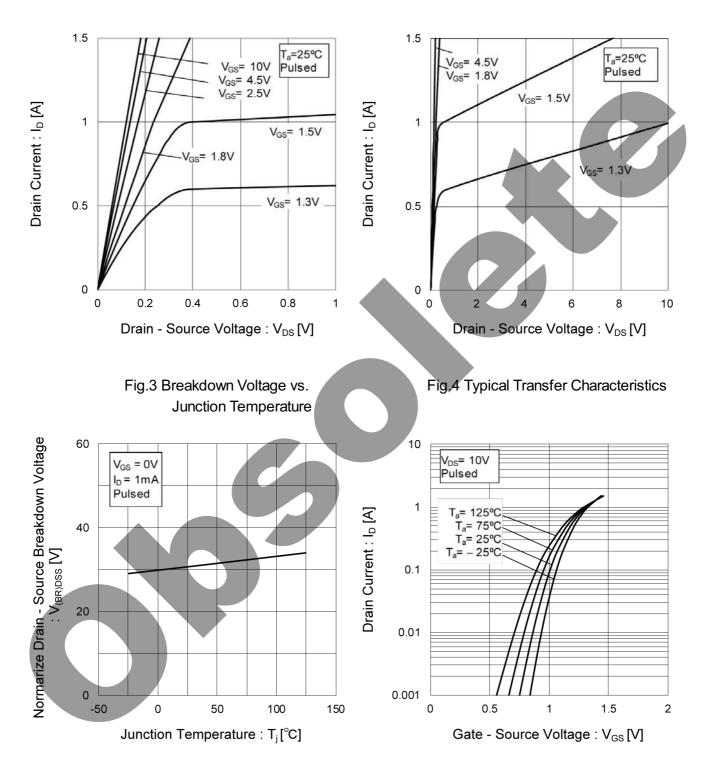
• Electrical characteristics ($T_a = 25^{\circ}C$)

< Diode >

Deremeter	Sumbol	Conditions	Values			Linit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward voltage	VF	I _F = 0.1A	-	-	0.36	V
		I _F = 0.5A	-	-	0.52	V
Reverse current	I _R	V _R = 20V	-	-	100	μA

- *1 Pw $\leq 0\mu s$, Duty cycle $\leq 1\%$
- *2 Mounted on a ceramic board (30×30×0.8mm)
- *3 60Hz · 1cycle
- *4 Mounted on a FR4 (12×20×0.8mm,Cu pad:240mm²)
- *5 Pulsed





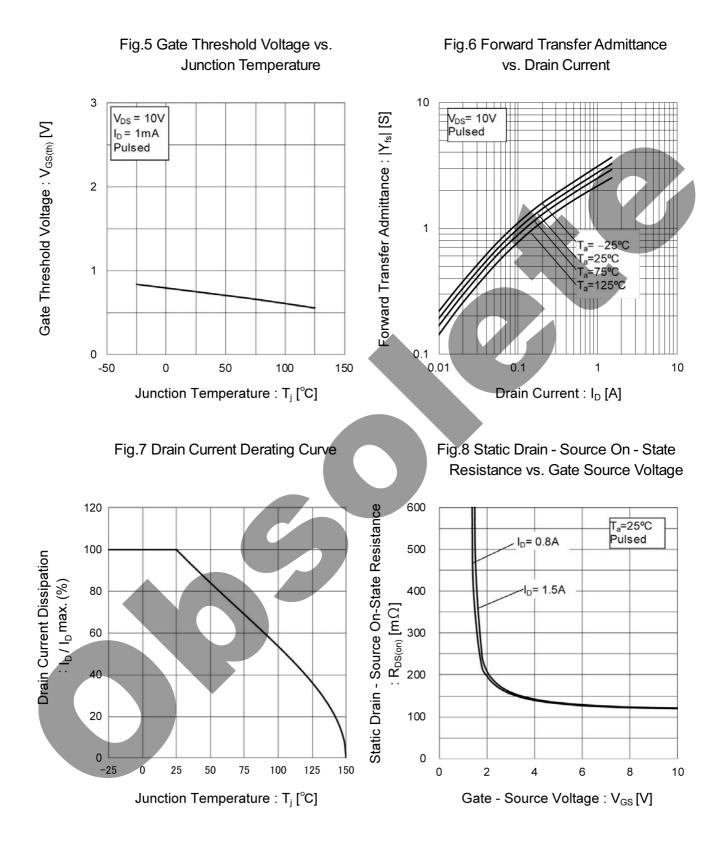
• Electrical characteristic curves < MOSFET >

Fig.1 Typical Output Characteristics(I)

Fig.2 Typical Output Characteristics(II)

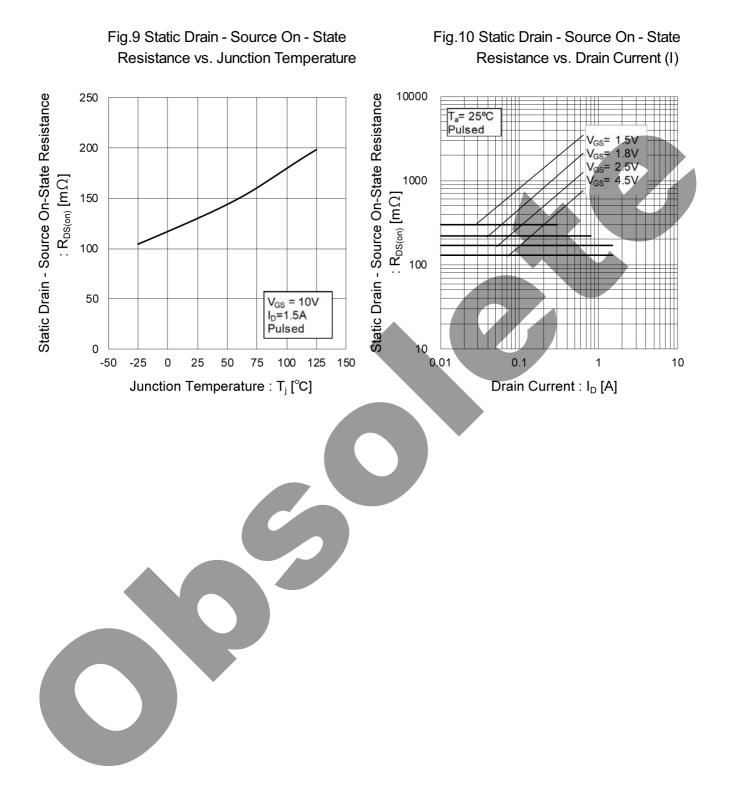


• Electrical characteristic curves < MOSFET >



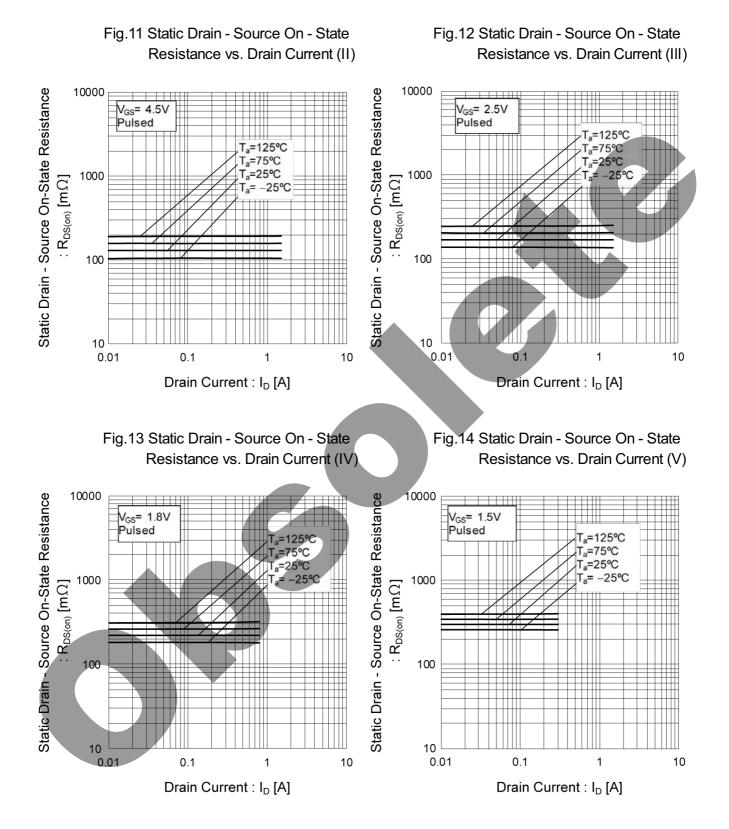


•Electrical characteristic curves <MOSFET>



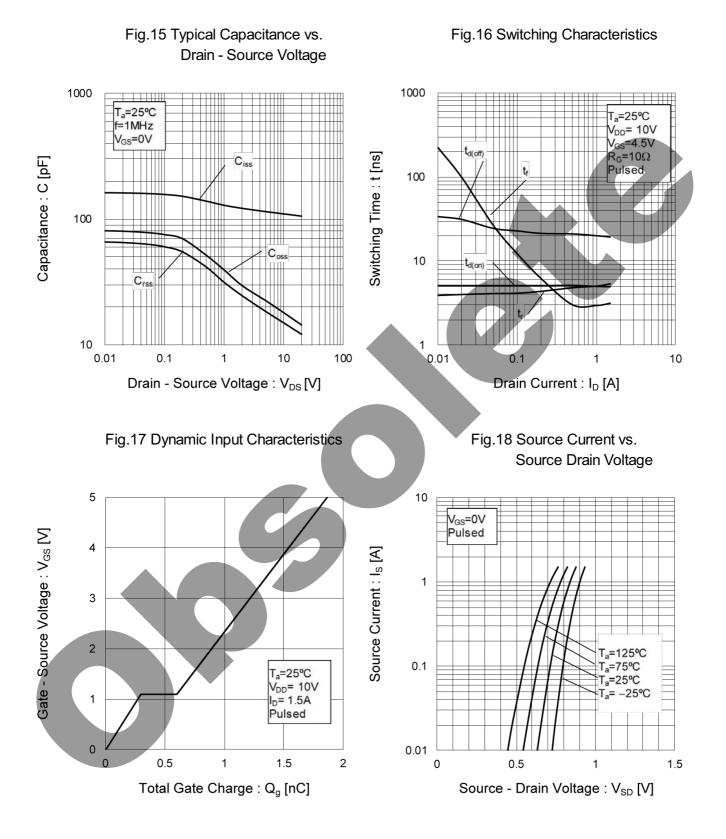


• Electrical characteristic curves < MOSFET>



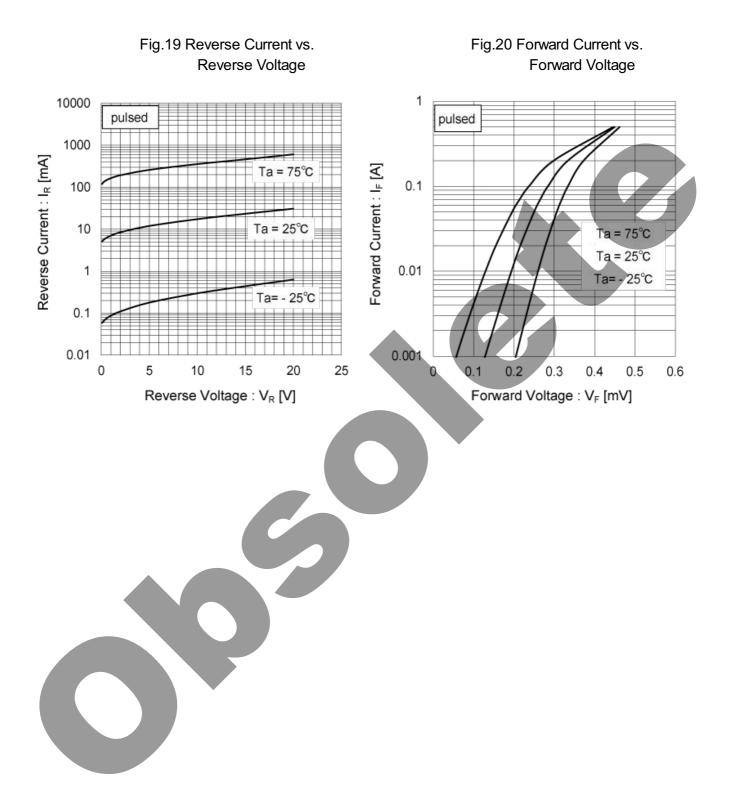


Electrical characteristic curves <MOSFET>



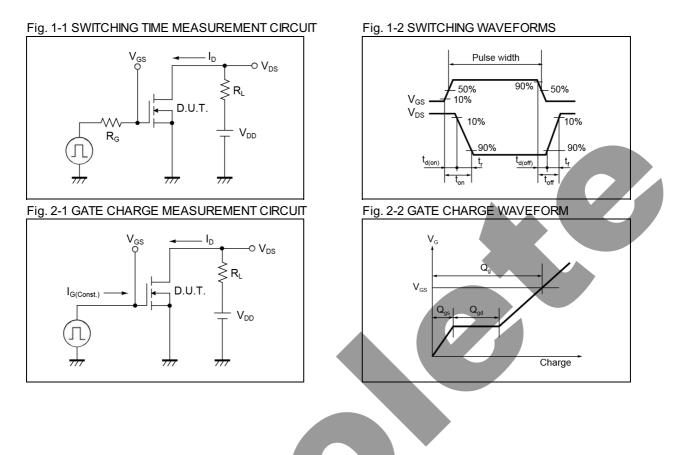


•Electrical characteristic curves <Di>





Measurement circuits



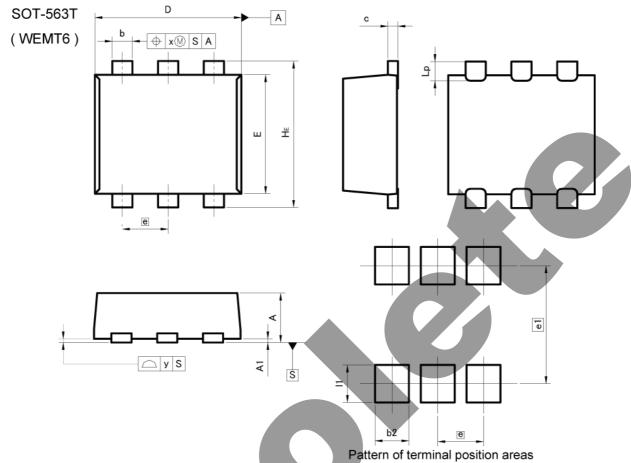
Notice

- SBD has a large reverse leak current compared to other type of diode. Therefore, it would raise a junction temperature, and increase a reverse power loss. Further rise of inside temperature would cause a thermal runaway. This built-in SBD has low V_F characteristics and therefore, higher leak current. Please consider enough the surrounding temperature, generating heat of MOSFET and the reverse current.
- 2. This product might cause chip aging and breakdown under the large electrified environment. Please consider to design ESD protection circuit.



ES6U2

Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

ROHM

DIM	MILIME	TERS	INC	HES
DIN	MIN	MAX	MIN	MAX
А	0.55	0.65	0.022	0.026
A1	0.00	0.05	0.000	0.002
b	0.17	0.27	0.007	0.011
С	0.08	0.18	0.003	0.007
D	1,50	1.70	0.059	0.067
E	1.20	1.40	0.047	0.055
е	0.5	0	0.020	
HE	1.50	1.70	0.059	0.067
Lp	0.11	0.31	0.004	0.012
x	-	0.10		0.004
y	-	0.10	÷.	0.004

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
b2	-	0.37	T	0.015
e1	1.	1.29		051
11	-	0.41	1	0.016

Dimension in mm/inches

Notice

Precaution on using ROHM Products

1. Our Products are designed and manufactured for application in ordinary electronic equipment (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (^{Note 1}), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASS II b	CLASSII
CLASSⅣ		CLASSⅢ	

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
 - [a] Installation of protection circuits or other protective devices to improve system safety
 - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
- 3. Our Products are designed and manufactured for use under standard conditions and not under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:
 - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

Precaution for Foreign Exchange and Foreign Trade act

Since concerned goods might be fallen under listed items of export control prescribed by Foreign exchange and Foreign trade act, please consult with ROHM in case of export.

Precaution Regarding Intellectual Property Rights

- All information and data including but not limited to application example contained in this document is for reference only. ROHM does not warrant that foregoing information or data will not infringe any intellectual property rights or any other rights of any third party regarding such information or data.
- 2. ROHM shall not have any obligations where the claims, actions or demands arising from the combination of the Products with other articles such as components, circuits, systems or external equipment (including software).
- 3. No license, expressly or implied, is granted hereby under any intellectual property rights or other rights of ROHM or any third parties with respect to the Products or the information contained in this document. Provided, however, that ROHM will not assert its intellectual property rights or other rights against you or your customers to the extent necessary to manufacture or sell products containing the Products, subject to the terms and conditions herein.

Other Precaution

- 1. This document may not be reprinted or reproduced, in whole or in part, without prior written consent of ROHM.
- 2. The Products may not be disassembled, converted, modified, reproduced or otherwise changed without prior written consent of ROHM.
- 3. In no event shall you use in any way whatsoever the Products and the related technical information contained in the Products or this document for any military purposes, including but not limited to, the development of mass-destruction weapons.
- 4. The proper names of companies or products described in this document are trademarks or registered trademarks of ROHM, its affiliated companies or third parties.

General Precaution

- 1. Before you use our Products, you are requested to care fully read this document and fully understand its contents. ROHM shall not be in an y way responsible or liable for failure, malfunction or accident arising from the use of a ny ROHM's Products against warning, caution or note contained in this document.
- 2. All information contained in this docume nt is current as of the issuing date and subj ect to change without any prior notice. Before purchasing or using ROHM's Products, please confirm the latest information with a ROHM sale s representative.
- 3. The information contained in this document is provided on an "as is" basis and ROHM does not warrant that all information contained in this document is accurate an d/or error-free. ROHM shall not be in an y way responsible or liable for any damages, expenses or losses incurred by you or third parties resulting from inaccuracy or errors of or concerning such information.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by ROHM manufacturer:

Other Similar products are found below :

614233C 648584F IRFD120 JANTX2N5237 FCA20N60_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D TPCC8103,L1Q(CM MIC4420CM-TR VN1206L SBVS138LT1G 614234A 715780A NTNS3166NZT5G SSM6J414TU,LF(T 751625C BUK954R8-60E NTE6400 SQJ402EP-T1-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE2384 NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956 NTE2911 DMN2080UCB4-7 TK10A80W,S4X(S SSM6P69NU,LF DMP22D4UFO-7B DMN1006UCA6-7